

[Bibliography]

[Document Name]	Amendment to specification
[Receiver]	Commissioner
[Filing Date]	06 December 2002
[Applicant]	
[Name]	Integrated Process Systems
[Applicant code]	1-1998-097346-8
[Relationship to the case]	Applicant
[Attorney]	
[Name]	Youngpil Lee
[Attorney code]	9-1998-000334-6
[General Power of Attorney Registration No.]	2002-030299-1
[Indication of the case]	
[Application No.]	10-2002-0072380
[Application Date]	20 November 2002
[Date of Request for Examination]	20 November 2002
[Title]	Method for depositing thin film on wafer using Aluminum compound
[Reason for submission]	
[Receipt Number]	1-1-02-0383122-50
[Receipt Date]	20 November 2002
[Document to be amended]	Specification
[Items to be amended]	
[Item subject to amendment]	as attached
[Amendment method]	as attached
[Contact of amendment]	as attached
[Purpose]	We file as above according to Art. 13 of the Patent Law Enforcement rule, and according to Art. 8 of the Utility Model Law Enforcement rule. Attorney Youngpil Lee
[Fee]	
[Amendment fee]	0 won
[Additional Examination fee]	0 won
[Other fees]	0 won
[Total]	0 won
[Enclosures]	
1. Document certifying content of amendment	1 copy each